

# Infonote

AO-IN-2024-007-I1

## New lead frame for SOIC8 package family

15.03.2024

Dear Customer,

Please take note of this **Infonote** update (changes to previous Infonote AO-IN-2024-007-I are marked in blue).

This customer notification is for information only and does not require customer approval.

Objective:	New lead frame for SOIC8 package family	
Affected products:	191860091 AS5070A-HSOM SOIC8 LF T&RDP Q65114A0833 191860092 AS5070A-HSOT SOIC8 LF T&RDP Q65114A0834 191860093 AS5070B-HSOM SOIC8 LF T&RDP Q65114A0835 191860094 AS5070B-HSOM SOIC8 LF T&RDP Q65114A0836	
Reason for change:	Conversion of existing customized lead frame to new standardized lead frame.	
Description of change:	<u>Current status</u>	<u>New status</u>
	<del>Leadframe SOIC 8L XDLF (large matrix Leadframe)</del>  Leadframe SOIC 8L UDLF (Ultra density leadframe)	<del>Leadframe SOIC 8L XDLF (large matrix Leadframe) with slightly larger pad size</del>  Leadframe SOIC 8L XDLF (extreme density leadframe)
Time schedule:	Start of production: September 2024	
Assessment:	There will be no changes in terms of form, fit, function, quality, or reliability.	